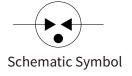


| Moisture sensitivity level:Level 1

### **FEATURES**

| Surface Mounting Design 3.2\*2.5\*2.5mm | High Current Handling Capability 1000A @ 8/20 µs | Low Capacitance and Insertion Loss | Quick Response and Long Service Life





## **APPLICATION INFORMATION**

Communication equipment.
Repeaters, Modems
Telephone Interface,Line cards.
Data communication equipment.

## **AGENCY APPROVALS**

Icon	Solderability	
RoHS	Compliance with 2011/65/EU	
HF	Compliance with IEC61249-2-21:2003	
<b>P</b>	Mean lead free	

# **PRODUCT CHARACTERISTICS**

Lead Material	Body Material	Terminal Finish
Copper or Fe-Ni alloy	Ceramics	100% Matte-Tin Plated



## **ELECTRICAL PARAMETER**

Parameter	Condition	Rating	Unit
DC Blocking Voltage 1)	100V/s	376-564	V
Impulse Spark-over Voltage	At 1kV/μs	for 99 % of measured values ≤1000	V
	At 1kV/μs	Typical values of distribution ≤950	V
Impulse Discharge Current 2)	arge Current 2) 8/20μs 1000		А
Insulation Resistance	DC=100V ≥ 1		GΩ
Capacitance at 1MHz	V <sub>DC</sub> =0.5V	$V_{DC} = 0.5V$ $\leq 0.5$	
Operating And Storage Temperature		-40-125	°C

# **ENVIRONMENTAL RELIABILITY CHARACTERISTICS**

Testing items	Technical standards
High Temperature Storage Test Temperature: 85°C; Time:2H	
Low Temperature Storage Test	Temperature: -40°C; Time:2H
Vibration Frequency: 10-500Hz; Amplitude: 0.15mm; Time: 45min	
Resistance of soldering heat	Temperature:260°C;Time of dip soldering :10s,1time

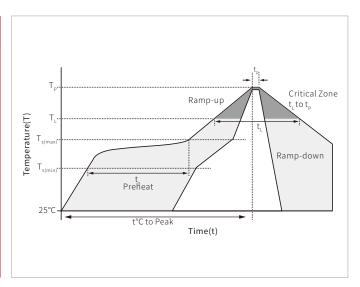
NOTE:Up-screen program can be specified by customer's request via contacting Semiware service

<sup>1)</sup> In ionized mode 2) Terms and waveforms in accordance with ITU-T Rec. K. 12; IEC 61643-21  $\,$ 

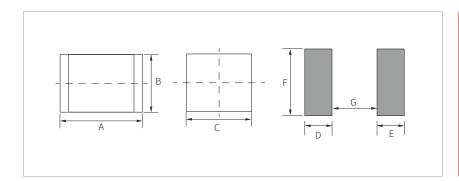


## **REFLOW PROFILE**

Reflow Condition		Lead-free assembly	
Temperature Min		150°C	
Pre Heat	Temperature Max	200°C	
	Time(min to max)	60 – 180 secs	
Average ra	mp up rate (Liquidus) Temp ( $T_L$ ) to peak	3°C/second max	
	$T_s(max)$ to $T_L$ - Ramp-up Rate		
Reflow	Temperature (T <sub>L</sub> ) (Liquidus)	217°C	
Rellow	$Time(min to max)(t_s)$	60 – 150 seconds	
Peak Temperature (T <sub>P</sub> )		260 °C	
Time within 5°C of actual peak Temperature (tp)		10-30 seconds	
Ramp-down Rate		6°C/second max	
Time 25°C to peak Temperature (T,)		8 minutes max.	
Do not exceed		260°C	



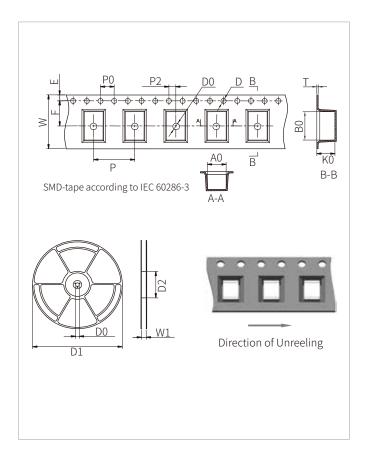
# **DIMENSIONS AND RECOMMENDED SOLDERING PAD**



Ref.	mm	
А	3.2±0.2mm	
В	2.5±0.2mm	
C 2.5±0.2mn		
D	1.2mm	
Е	1.2mm	
F	3mm	
G	1.5mm	



# TAPE AND REEL SPECIFICATION



Ref.	Dimensions		
Ket.	Millimeters	Inches	
W	12±0.3	0.472±0.012	
A0	2.8±0.1	0.110±0.004	
В0	3.5±0.1	0.138±0.004	
K0	2.8±0.1	0.110±0.004	
Р	8.0±0.1	0.315±0.004	
F	5.5±0.1	0.217±0.004	
E	1.75±0.1	0.069±0.004	
D	1.5+0.1/-0.0	0.059+0.004/-0.0	
P0	4±0.1	0.157±0.004	
P2	2±0.1	0.079±0.004	
Т	0.35±0.05	0.014±0.002	
D0	13.3±0.15	0.524±0.006	
D1	330±2	12.992±0.079	
D2	100+1/-2	3.937+0.039/-0.079	
W1	12.5±0.4	0.492±0.016	

# **ORDERING INFORMATION**

Part Number	Size	QTY/Reel	Reel Size
SG3225B470	3.2*2.5*2.5mm	2500PCS	13"



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### By QR Code





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